

3.0x1.0mm RIGHT ANGLE SMD CHIP LED **LAMP**



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: KPFA-3010RGBC-11

Hyper Red Green

Features

- 3.0mmx1.0mm right angle SMT LED, 1.5mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

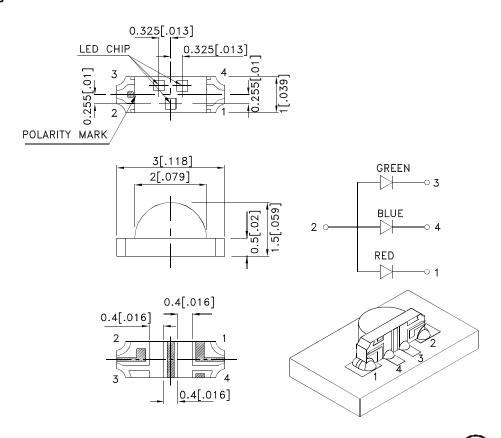
The Blue source color devices are made with InGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		-	Min.	Тур.	201/2
KPFA-3010RGBC-11	Hyper Red (AlGaInP)		80	140	120°
	Green (InGaN)	Water Clear	200	300	
	Blue (InGaN)		40	70	

Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green Blue	630 515 460		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red Green Blue	621 525 465		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green Blue	20 30 25		nm	IF=20mA
С	Capacitance	Hyper Red Green Blue	25 45 100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green Blue	2 3.3 3.3	2.5 4.1 4	V	IF=20mA
lr	Reverse Current	Hyper Red Green Blue		10 50 50	uA	V _R =5V

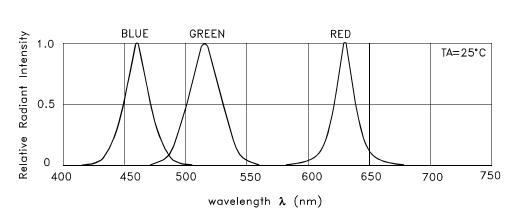
- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Green	Blue	Units			
Power dissipation	75	102.5	120	mW			
DC Forward Current	30	25	30	mA			
Peak Forward Current [1]	195	150	150	mA			
Reverse Voltage	5 V						
Operating Temperature	-40°C To +85°C						
Storage Temperature	-40°C To +85°C						

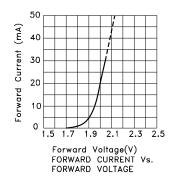
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

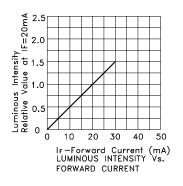
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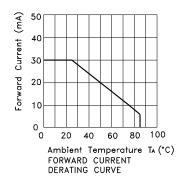


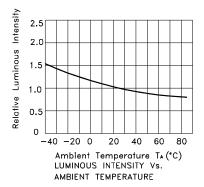
RELATIVE INTENSITY Vs. WAVELENGTH

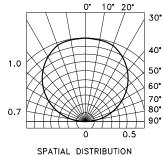
KPFA-3010RGBC-11 Hyper Red







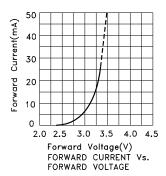


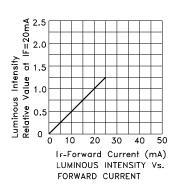


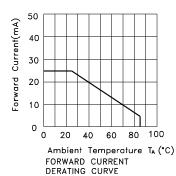
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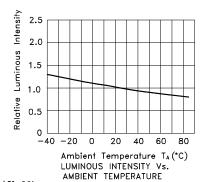
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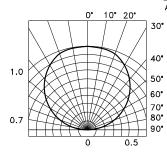
Green









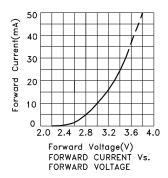


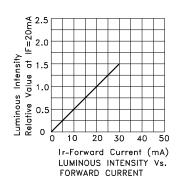
SPATIAL DISTRIBUTION

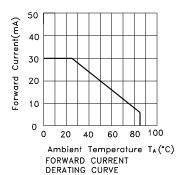
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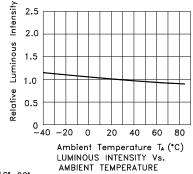
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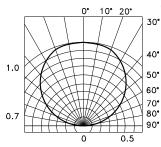
Blue











SPATIAL DISTRIBUTION

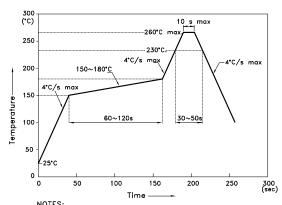
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



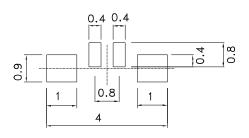
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - to high temperature.

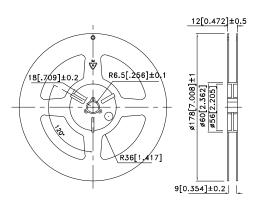
 3.Number of reflow process shall be 2 times or less.

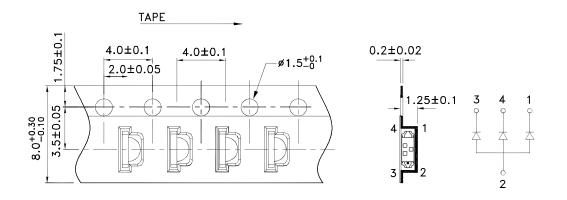
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units : mm)

Reel Dimension

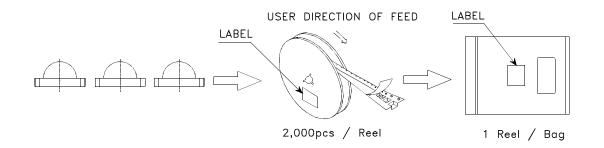


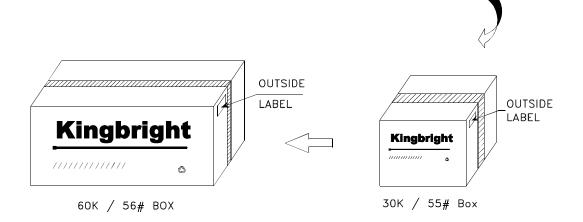


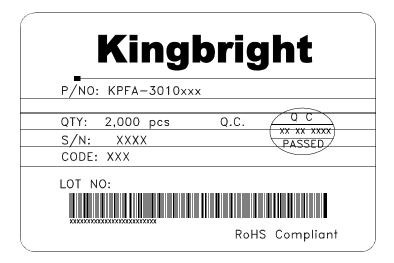
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PACKING & LABEL SPECIFICATIONS

KPFA-3010RGBC-11







Detailed application notes are listed on our website. http://www.kingbright.com/application notes

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